

RN5VD SERIES

LOW VOLTAGE DETECTOR WITH OUTPUT DELAY

NO. EA-027-160309

OUTLINE

The RN5VD Series are CMOS-based voltage detector ICs with high detector threshold accuracy and ultra-low supply current, which can be operated at an extremely low voltage and is used for system reset as an example.

Each of these ICs consists of a voltage reference unit, a comparator, resistor net for detector threshold setting, an output driver, a hysteresis circuit, and an output delay circuit. The detector threshold is fixed with high accuracy internally and does not require any adjustment. Two output types, Nch open drain type and CMOS type are available.

Since the package for these ICs is SOT-23-5 package, high density mounting of the ICs on board is possible.

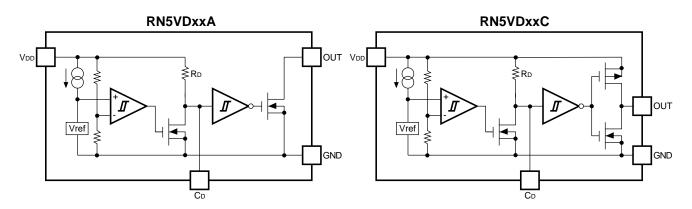
FEATURES

Built-in Output Delay Circuit	Typ. 100ms with an external capacitor : 0.15μF
Supply Current	Typ. 1.0μA (RN5VD15x, VDD=3.5V)
Operating Voltage Range	0.7 to 10.0V (Topt=25°C)
Detector Threshold Range	0.9V to 6.0V (0.1V steps)
Detector Threshold Accuracy	±2.5%
Temperature-Drift Coefficient of Detector Threshold	Typ. ±100ppm/°C
Output Types	Nch Open Drain and CMOS
Package	SOT-23-5

APPLICATIONS

- CPU and Logic Circuit Reset
- Battery Checker
- Window Comparator
- · Wave Shaping Circuit
- Battery Back-up Circuit
- Power Failure Detector

BLOCK DIAGRAMS



SELECTION GUIDE

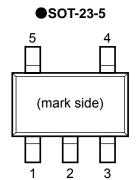
The detector threshold, and the output type for the ICs can be selected at the users' request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RN5VDxx*A-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes

xx: The detector threshold can be designated in the range from 0.9V(09) to 6.0V(60) in 0.1V steps.

- * : Designation of Output Type
 - (A) Nch Open Drain
 - (C) CMOS

PIN CONFIGURATION



PIN DESCRIPTION

Pin No.	Symbol	Pin Description
1	OUT	Output Pin ("L" at Detection)
2	V _{DD}	Input Pin
3	GND	Ground Pin
4	NC	No Connection
5	С	Pin for external capacitor (for setting output delay)

ABSOLUTE MAXIMUM RATINGS

Symbol	Item		Ratings	Unit				
V _{DD}	Supply Voltage		12					
Vout	Output Voltage	CMOS	Vss -0.3 to V _{DD} +0.3	V				
V 001	Output Voltage	Nch	Vss−0.3~12	V				
louт	Output Current		70					
PD	Power Dissipation (SOT-23-5)*		420	mW				
Topt	Operating Temperature Range		-40 to +85	°C				
Tstg	Storage Temperature Range		°C					
Tsolder	Lead Temperature (Soldering)		260°C 10s					

^{*)} For Power Dissipation, please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

ELECTRICAL CHARACTERISTICS

• RN5VD09A/C

Topt=25°C

Symbol	Item		Conditions	Min.	Тур.	Max.	Unit.
-Vdet	Detector Threshold			0.878	0.900	0.922	V
VHYS	Detector Threshold Hysteresis			0.027	0.045	0.063	V
Tan	Complex Comment		VDD=0.8V		1.5	3.7	^
Iss	Supply Current		VDD=2.9V		0.9	2.7	μA
VDDH	Maximum Operating Voltage					10	V
V	Minimum Operating Voltage		Topt=25°C		0.55	0.70	N/
VDDL	(Note 1)		–30°C≤Topt≤85°C		0.65	0.80	V
		N. I	Vds=0.05V, Vdd=0.7V	0.01	0.05		
Iout	Output Current	Nch	Vds=0.5V, Vdd=0.85V	0.05	0.50		mA
		Pch	Cch VDS=-2.1V, VDD=4.5V		2.0		mA
VTCD	CD pin Threshold Voltage		V _{DD} =0.99V	0.297	0.495	0.693	V
Ton	Cominginal Comment	7	$V_{\rm DS}=0.1{ m V},{ m V}_{\rm DD}=0.7{ m V}$	2.0	30		^
Icd	CD pin Sink Current	V	DS=0.5V, VDD=0.85V	10.0	100.0		μA
RD	Delay Resistance			0.5	1.0	2.0	ΜΩ
$\frac{\Delta \text{VDET}}{\Delta \text{Topt}}$	Detector Threshold Temperature Coefficient		–30°C≤Topt≤85°C		±100		ppm/°C

⁽Note 1) Minimum Operating Voltage means the value of input voltage when output voltage maintains 0.1V or less, provided that in the case of Nch Open Drain Type Products, the pull-up resistance is set at 470kΩ, and the pull-up voltage is set at 5.0V.

• RN5VD18A/C

Topt=25°C

Symbol	Item		Conditions	Min.	Тур.	Max.	Unit.
-VDET	Detector Threshold			1.755	1.800	1.845	V
VHYS	Detector Threshold Hysteresis			0.054	0.090	0.126	V
Lag	Summler Commont		Vdd=1.7V		2.5	5.0	^
Iss	Supply Current		Vdd=3.8V		1.0	3.0	μA
VDDH	Maximum Operating Voltage					10	V
VDDL	Minimum Operating Voltage (Note 1)		Topt=25°C –30°C≤Topt≤85°C		0.55 0.65	0.70 0.80	V
		NI-L	VDS=0.05V, VDD=0.7V		0.05		A
Іоит	Output Current	Nch	Vds=0.5V, Vdd=1.5V	1.0	2.0		mA
		Pch	Vds=-2.1V, Vdd=4.5V	1.0	2.0		mA
VTCD	CD pin Threshold Voltage		VDD=1.98V	0.693	0.990	1.287	V
Lap	Comin Simb Chamont	V	$V_{\rm DS}=0.1 \mathrm{V}, \mathrm{V}_{\rm DD}=0.7 \mathrm{V}$	2.0	30		η, Λ
ICD	CD pin Sink Current	Vds=0.5V, Vdd=1.5V		200.0	800.0		μA
RD	Delay Resistance			0.5	1.0	2.0	ΜΩ
$\frac{\Delta \! - \! V_{\rm DET}}{\Delta Topt}$	Detector Threshold Temperature Coefficient		–30°C≤Topt≤85°C		±100		ppm/°C

⁽Note 1) Minimum Operating Voltage means the value of input voltage when output voltage maintains 0.1V or less, provided that in the case of Nch Open Drain Type Products, the pull-up resistance is set at $470k\Omega$, and the pull-up voltage is set at 5.0V.

RN5VD

• RN5VD27A/C

Topt=25°C

Symbol	Item		Conditions	Min.	Тур.	Max.	Unit.
-VDET	Detector Threshold			2.633	2.700	2.767	V
VHYS	Detector Threshold Hysteresis			0.081	0.135	0.189	V
Iss	Supply Cumont		VDD=2.6V		3.5	7.0	11.Δ
ISS	Supply Current		Vdd=4.7V		1.1	3.3	. μΑ
Vddh	Maximum Operating Voltage					10	V
VDDL	Minimum Operating Voltage (Note 1)		Topt=25°C -30°C≤Topt≤85°C		0.55 0.65	0.70 0.80	V
		Mah	Nch VDS=0.05V, VDD=0.7V		0.05		A
Iout	Output Current	VDS=0.5V, VDD=1.5V		1.0	2.0		mA
		Pch	Vds=-2.1V, Vdd=4.5V	1.0	2.0		mA
V _{TCD}	CD pin Threshold Voltage		$V_{\rm DD}=2.97V$	1.188	1.485	1.782	V
Icp	CD pin Sink Current	v	$V_{\rm DS}=0.1 \mathrm{V}, \mathrm{V}_{\rm DD}=0.7 \mathrm{V}$	2.0	30		μA
ICD	CD pili Silik Current	V	Vds=0.5V, Vdd=1.5V		800.0		μΑ
R_{D}	Delay Resistance			0.5	1.0	2.0	ΜΩ
$\frac{\Delta - V_{DET}}{\Delta Topt}$	Detector Threshold Temperature Coefficient		–30°C≤Topt≤85°C		±100		ppm/°C

⁽ Note 1) Minimum Operating Voltage means the value of input voltage when output voltage maintains 0.1V or less, provided that in the case of Nch Open Drain Type Products, the pull-up resistance is set at 470kΩ, and the pull-up voltage is set at 5.0V.

• RN5VD36A/C

 $Topt=25^{\circ}C$

Symbol	Item		Conditions	Min.	Тур.	Max.	Unit.
-VDET	Detector Threshold			3.510	3.600	3.690	V
VHYS	Detector Threshold Hysteresis			0.108	0.180	0.252	V
Lag	Summly Commont		Vdd=3.47V		4.5	9.0	^
Iss	Supply Current		VDD=5.6V		1.2	3.6	- μA
VDDH	Maximum Operating Voltage					10	V
VDDL	Minimum Operating Voltage (Note 1)		Topt=25°C -30°C≤Topt≤85°C		0.55 0.65	0.70 0.80	V
		NI-L	Vds=0.05V, Vdd=0.7V	0.01	0.05		A
Іоит	Output Current	Nch	Vds=0.5V, Vdd=1.5V	1.0	2.0		mA
		Pch	Vds=-2.1V, Vdd=4.5V	1.0	2.0		mA
VTCD	CD pin Threshold Voltage		Vdd=3.96V	1.584	1.980	2.376	V
ICD	Comin Sink Champan	V	$V_{\rm DS}=0.1 \mathrm{V}, \mathrm{V}_{\rm DD}=0.7 \mathrm{V}$	2.0	30		
1CD	CD pin Sink Current	V	$V_{\rm DS}$ =0.5 V , $V_{\rm DD}$ =1.5 V		800.0		- μA
RD	Delay Resistance			0.5	1.0	2.0	ΜΩ
$\frac{\Delta - V_{\rm DET}}{\Delta Topt}$	Detector Threshold Temperature Coefficient		–30°C≤Topt≤85°C		±100		ppm/°C

⁽Note 1) Minimum Operating Voltage means the value of input voltage when output voltage maintains 0.1V or less, provided that in the case of Nch Open Drain Type Products, the pull-up resistance is set at $470 \text{k}\Omega$, and the pull-up voltage is set at 5.0V.

• RN5VD45A/C

Topt=25°C

Symbol	Item		Conditions	Min.	Тур.	Max.	Unit.
–Vdet	Detector Threshold			4.388	4.500	4.612	V
VHYS	Detector Threshold Hysteresis			0.135	0.225	0.315	V
Tan	Committee Committee		VDD=4.34V		5.5	11.0	^
Iss	Supply Current		Vdd=6.5V		1.3	3.9	μA
VDDH	Maximum Operating Voltage					10	V
$ m V_{DDL}$	Minimum Operating Voltage (Note 1)		Topt=25°C -30°C≤Topt≤85°C		0.55 0.65	0.70 0.80	v
		Nch	Vds=0.05V, Vdd=0.7V	0.01	0.05		1
Iout	Output Current	NCII	Vds=0.5V, Vdd=1.5V	1.0	2.0		mA
		Pch	Vds=-2.1V, Vdd=8.0V	1.5	3.0		mA
VTCD	CD pin Threshold Voltage		$V_{\rm DD}$ =4.95 V	1.980	2.475	2.970	V
Icd	Comin Sinh Comment	V	$V_{\rm DS}=0.1{ m V},{ m V}_{\rm DD}=0.7{ m V}$	2.0	30		μA
1CD	CD pin Sink Current	V	Vds=0.5V, Vdd=1.5V		800.0		μΑ
R_{D}	Delay Resistance			0.5	1.0	2.0	ΜΩ
$\frac{\Delta \!\!-\!\! V_{\rm DET}}{\Delta Topt}$	Detector Threshold Temperature Coefficient		–30°C≤Topt≤85°C		±100		ppm/°C

⁽Note 1) Minimum Operating Voltage means the value of input voltage when output voltage maintains 0.1V or less, provided that in the case of Nch Open Drain Type Products, the pull-up resistance is set at $470k\Omega$, and the pull-up voltage is set at 5.0V.

• RN5VD54A/C

Topt=25°C

Symbol	Item		Conditions	Min.	Тур.	Max.	Unit.
-VDET	Detector Threshold			5.265	5.400	5.535	V
VHYS	Detector Threshold Hysteresis			0.162	0.270	0.378	V
Iss	Summler Commont		VDD=5.2V		6.0	12.0	μA
ISS	Supply Current		$V_{\rm DD}=7.4V$		1.4	4.2	μΑ
VDDH	Maximum Operating Voltage					10	V
VDDL	Minimum Operating Voltage (Note 1)		Topt=25°C -30°C≤Topt≤85°C		0.55 0.65	0.70 0.80	V
		Mol	$\begin{array}{c} \text{Nch} & \begin{array}{c} V_{DS=0.05V,\ V_{DD=0.7V}} \\ \\ \hline V_{DS=0.5V,\ V_{DD=1.5V}} \end{array}$		0.05		A
Iout	Output Current	NCII			2.0		mA
		Pch	Vds=-2.1V, Vdd=8.0V	1.5	3.0		mA
VTCD	CD pin Threshold Voltage		Vdd=5.94V	2.376	2.970	3.564	V
Lan	Comin Simb Chamont	7	$V_{\rm DS}=0.1 \mathrm{V}, V_{\rm DD}=0.7 \mathrm{V}$	2.0	30		η, Λ
ICD	CD pin Sink Current	Vds=0.5V, Vdd=1.5V		200.0	800.0		μA
RD	Delay Resistance			0.5	1.0	2.0	ΜΩ
$\frac{\Delta - V_{DET}}{\Delta Topt}$	Detector Threshold Temperature Coefficient		–30°C≤Topt≤85°C		±100		ppm/°C

⁽Note 1) Minimum Operating Voltage means the value of input voltage when output voltage maintains 0.1V or less, provided that in the case of Nch Open Drain Type Products, the pull-up resistance is set at 470kΩ, and the pull-up voltage is set at 5.0V.

ELECTRICAL CHARACTERISTICS BY DETECTOR THRESHOLD

• RN5VD09A/C to RN5VD39A/C

	Detect	tor Thre	eshold	Ну	stere	sis	Supp	ly Cur	rent 1	Supp	ly Cur	rent 2	Output Current 1			Output Current 2				
Part Number.		VDET (V)	٧	'нүѕ (\	/)	Iss1 (μA)			Iss2 (μA)			IOUT1 (mA)			І оит2 (mA)				
	Min.	Тур.	Max.	Min.	Тур.	Max.	condi- tions	Тур.	Max.	condi- tions	Тур.	Max.	condi- tions	Min.	Тур.	cond	itions	Min.	Тур.	
RN5VD09A/C	0.878	0.900	0.922	0.027	0.045	0.063		1.5	3.7		0.9	2.7					VDD=	0.05	0.50	
RN5VD10A/C	0.975	1.000	1.025	0.030	0.050	0.070		1.0	5.1								0.85V	0.05	0.50	
RN5VD11A/C	1.073	1.100	1.127	0.033	0.055	0.077		1.8	4.5											
RN5VD12A/C	1.170	1.200	1.230	0.036	0.060	0.084		1.0	4.5											
RN5VD13A/C	1.268	1.300	1.332	0.039	0.065	0.091		0.0	F 0								VDD= 1.0V	0.2	1.0	
RN5VD14A/C	1.365	1.400	1.435	0.042	0.070	0.098	VDD= (-VDET) -0.10V	2.0	5.0		1.0	20					1.0 V			
RN5VD15A/C	1.463	1.500	1.537	0.045	0.075	0.105					1.0	3.0								
RN5VD16A/C	1.560	1.600	1.640	0.048	0.080	0.112			2.5 5.0							Nch V _{DS} = 0.5V				
RN5VD17A/C	1.658	1.700	1.742	0.051	0.085	0.119		2.5						ı	1 0.05					
RN5VD18A/C	1.755	1.800	1.845	0.054	0.090	0.126														
RN5VD19A/C	1.853	1.900	1.947	0.057	0.095	0.133														
RN5VD20A/C	1.950	2.000	2.050	0.060	0.100	0.140														
RN5VD21A/C	2.048	2.100	2.152	0.063	0.105	0.147														
RN5VD22A/C	2.145	2.200	2.255	0.066	0.110	0.154		3.0	6.0				Nch							
RN5VD23A/C	2.243	2.300	2.357	0.069	0.115	0.161				V _{DD=}			V _{DS=}							
RN5VD24A/C	2.340	2.400	2.460	0.072	0.120	0.168			((-VDET)	T)	3.3	0.05V VDD= 0.7V	0.01						
RN5VD25A/C	2.438	2.500	2.562	0.075	0.125	0.175				+2.0V	1.1									
RN5VD26A/C	2.535	2.600	2.665	0.078	0.130	0.182													2.0	
RN5VD27A/C	2.633	2.700	2.767	0.081	0.135	0.189		3.5	7.0								VDD=	1.0		
RN5VD28A/C	2.730	2.800	2.870	0.084	0.140	0.196											1.5V	1.0		
RN5VD29A/C	2.828	2.900	2.972	0.087	0.145	0.203														
RN5VD30A/C	2.925	3.000	3.075	0.090	0.150	0.210							1							
RN5VD31A/C	3.023	3.100	3.177	0.093	0.155	0.217														
RN5VD32A/C	3.120	3.200	3.280	0.096	0.160	0.224		4.0	8.0											
RN5VD33A/C	3.218	3.300	3.382	0.099	0.165	0.231														
RN5VD34A/C	3.315	3.400	3.485	0.102	0.170	0.238	VDD= (-VDET) -0.13V				10									
RN5VD35A/C			3.587								1.2	3.6								
RN5VD36A/C	_		3.690		_															
RN5VD37A/C	3.608	3.700	3.792	0.111	0.185	0.259		4.5	9.0											
RN5VD38A/C	3.705	3.800	3.895	0.114	0.190	0.266														
RN5VD39A/C	3.803	3.900	3.997	0.117	0.195	0.273														

(Note) Refer to the previously defined "Minimum Operating Voltage".

Condition 1 : Topt=25°C Condition 2 : −30°C≤Topt≤85°C

Topt=25°C

Outp	ut Curr	ent 3		m Oper- /oltage	Co Pi	n Thres	shold V	oltage	C _D I	Pin Ou urrent	tput 1	Co Pi	n Outp	ut Cur	rent 2	Re	Delay esistan		Detector Threshold Tempco.	
loı	JT3 (m	A)	VDDI	L (V)		V TC	o (V)		lo	:D1 (µ/	A)		ICD2	(μΑ)		R	2 M) d	2)	Δ–V _{DET} ΔTopt	(ppm/°C)
condi- tions	Min.	Тур.	Тур.	Max.	condi- tions	Min.	Тур.	Max.	condi- tions	Min.	Тур.	cond	itions	Min.	Тур.	Min.	Тур.	Max.	condi- tions	Тур.
						V _{DD} × 0.3	V _{DD} × 0.5	V _{DD} × 0.7					V _{DD} = 0.85V	10	100					
													VDD= 1.0V	50	200					
						VDDX 0.35	VDDX 0.5	VDDX 0.65												
Pch VDS= -2.1V VDD= 4.5V	1.0	2.0	0.65	Condition1 0.70 Condition2 0.80	VDD= (-VDET) × 1.1V	VDDX 0.4	0.5	V _{DD} × 0.6	VDS= 0.1V VDD= 0.7V	2.0	30	VDS= 0.5V	V _{DD} = 1.5V	200	800	0.5	1.0	2.0	-30°C≤ Topt ≤85°C	±100

RN5VD

• RN5VD40A/C to RN5VD60A/C

	Detector Threshold			Hysteresis			Supply Current 1			Supply Current 2			Output Current 1			Output Current 2			
Part Number.	-VDET (V)			VHYS (V)			Iss1 (μA)			Iss2 (μA)			IOUT1 (mA)			IOUT2 (mA)			
	Min.	Тур.	Max.	Min.	Тур.	Max.	condi- tions	Тур.	Max.	condi- tions	Тур.	Max.	condi- tions	Min.	Тур.	cond	itions	Min.	Тур.
RN5VD40A/C	3.900	4.000	4.100	0.120	0.200	0.280													
RN5VD41A/C	3.998	4.100	4.202	0.123	0.205	0.287	1 VDD= (-VDET) -0.16V 2		11.0	VDD= (-VDET) +2.0V	1.3	3.9	Nch VDS= 0.05V VDD= 0.7V		0.05	Nch VDS= 0.5V	V _{DD} = 1.5V	1.0	2.0
RN5VD42A/C	4.095	4.200	4.305	0.126	0.210	0.294													
RN5VD43A/C	4.193	4.300	4.407	0.129	0.215	0.301													
RN5VD44A/C	4.290	4.400	4.510	0.132	0.220	0.308													
RN5VD45A/C	4.388	4.500	4.612	0.135	0.225	0.315													
RN5VD46A/C	4.485	4.600	4.715	0.138	0.230	0.322													
RN5VD47A/C	4.583	4.700	4.817	0.141	0.235	0.329													
RN5VD48A/C	4.680	4.800	4.920	0.144	0.240	0.336													
RN5VD49A/C	4.778	4.900	5.022	0.147	0.245	0.343													
RN5VD50A/C	4.875	5.000	5.125	0.150	0.250	0.350		6.0											
RN5VD51A/C	4.973																		
RN5VD52A/C	5.070	5.200	5.330	0.156	0.260	0.364													
RN5VD53A/C	5.168	5.300	5.432	0.159	0.265	0.371													
RN5VD54A/C	5.265					_	V _{DD} =												
RN5VD55A/C	_		5.637				(-VDET)				1.4	4.2							
RN5VD56A/C			5.740			_	-0.20V												
RN5VD57A/C	_		5.842			\vdash		6.5	13.0										
RN5VD58A/C	5.655	_	_				- 1												
RN5VD59A/C	5.753	5.900	6.047	0.177	0.295	0.413													
RN5VD60A/C	5.850	6.000	6.150	0.180	0.300	0.420													

(Note) Refer to the previously defined "Minimum Operating Voltage".

Condition 1 : Topt=25°C Condition 2 : −30°C≤Topt≤85°C

Topt=25°C

Output Current 3 Minimum ating Vo		m Oper- /oltage	Oper- Itage CD Pin Threshold Voltage				CD Pin Output Current 1			CD Pin Output Current 2				Delay Resistance			Detector Threshold Tempco.			
IOUT3 (mA) VDDL		L (V)	VTCD (V)				Icd1 (µA)			IOUT1 (mA)				louт2 (mA)			$\frac{\Delta - V_{DET}}{\Delta Topt} (ppm/^{\circ}C)$			
condi- tions	Min.	Тур.	Тур.	Max.	condi- tions	Min.	Тур.	Max.	condi- tions	Min.	Тур.	cond	itions	Min.	Тур.	condi- tions	Тур.	Max.	condi- tions	Тур.
Pch VDS= -2.1V VDD= 8.0V	1.5	3.0	(Note1) Condition1 0.55 Condition2 0.65	Condition1 0.70	VDD= (-VDET)	VDD× 0.4	VDDX 0.5	Vdd× 0.6V	V _{DS} = 0.1V V _{DD} = 0.7V	2.0	30	VDS= 0.5V	V _{DD} = 1.5V	200	800	0.5	1.0	2.0	–30°C≤ Topt ≤85°C	±100

OPERATION

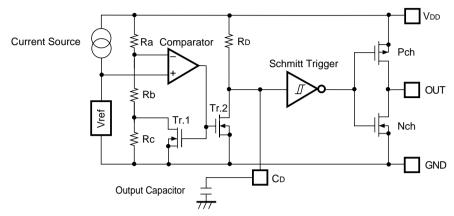
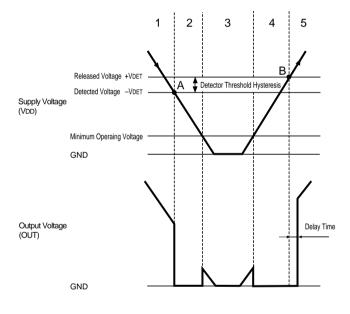


Fig. 1 Block Diagram



Step)	Step 1	Step 2 Step 3		Step 4	Step 5	
Comparato Input Vo	I	і Іп Іп		II	I		
Comparato	r Output	L	Н	Indefinite	Н	L	
Tr. 1	OFF ON Indefinite		ON	OFF			
O44 Th	Nch	OFF	ON	Indefinite	ON	OFF	
Output Tr.	Pch	ON	OFF	Indefinite	OFF	ON	

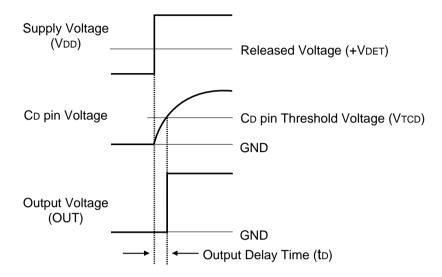
$$I. \quad \frac{Rb + Rc}{Ra + Rb + Rc} \cdot V_{DD}$$

II.
$$\frac{Rb}{Ra + Rh} \cdot V_{DD}$$

Fig. 2 Operation Diagram

- Step 1. Output voltage is equal to pull-up voltage.
- Step 2. When input voltage (VDD) reaches the state of Vref≥VDD · (Rb+Rc) / (Ra+Rb+Rc) at point A (Detected Voltage −VDET), the output of comparator is reversed, so that output voltage becomes GND. Discharging is performed from CD pin connected to an external capacitor. No delay time is generated.
- Step 3. Output voltage becomes indefinite when power source voltage (VDD) is smaller than minimum operating voltage. When the output is pulled up, VDD is output.
- Step 4. Output voltage becomes equal to GND.
- Step 5. When input voltage (VDD) reaches the state of Vref ≤ VDD · Rb/(Ra+Rb) at Point B (Released Voltage +VDET), the output of comparator is reversed, and the external capacitor is charged through CD pin, so that output voltage becomes equal to pulled-up voltage after a delay time to (=0.69×10°×CD).

Output Delay Operation



When the supply voltage crosses the released voltage (+VDET) from a low value to a value higher than the released voltage (+VDET), the CD pin voltage starts to increase (starts to charge the external capacitor).

The output voltage is maintained at "L" level until the CD pin voltage reaches to VTCD (CD pin threshold voltage) after that the output voltage is reversed to "H".

The time period from beginning of charging capacitor to output voltage reversing represents the output delay (t_D) .

Output Delay Time

Delay time (tD) can be set accordance with the capacitance CD of external capacitor as below tD=0.69 \times 10 ° \times CD (s)

TEST CIRCUITS

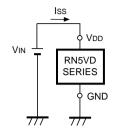


Fig. 3 Supply Current test Circuit

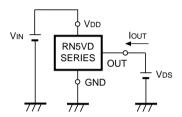


Fig. 5 Nch Driver Output Current Test Circuit

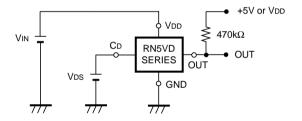
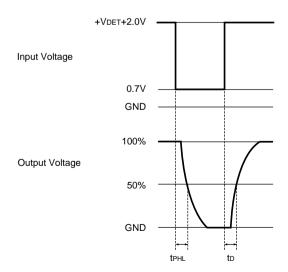


Fig. 7 C_D pin Threshold Voltage Test Circuit



*) at Fig.4,7,9. CMOS Output Type does not need a pull-up resistor.

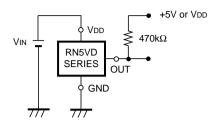


Fig. 4 Detector Threshold Test Circuit

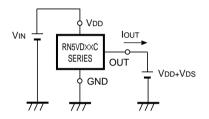


Fig. 6 Pch Driver Output Current Test Circuit

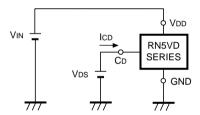


Fig. 8 C_D pin Sink Current Test Circuit

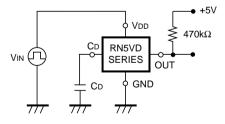
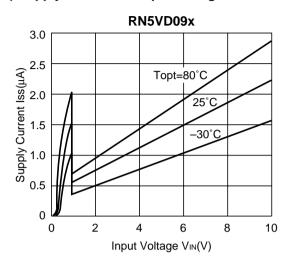
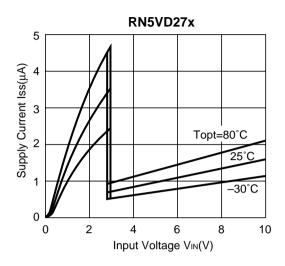


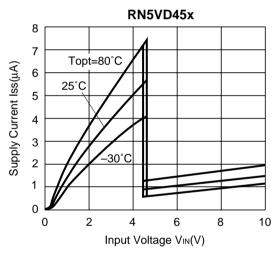
Fig. 9 Output Delay Time Test Circuit

TYPICAL CHARACTERISTICS

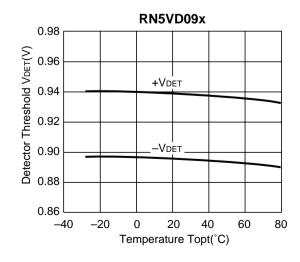
1) Supply Current vs. Input Voltage

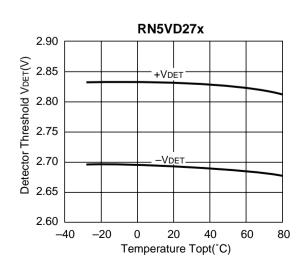


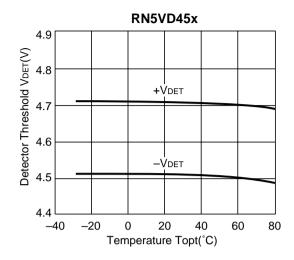




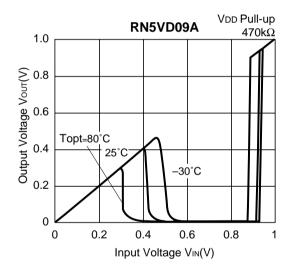
2) Detector Threshold vs. Temperature

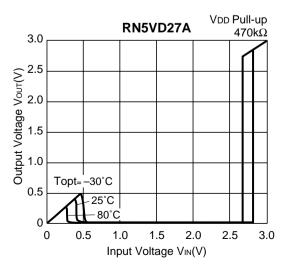


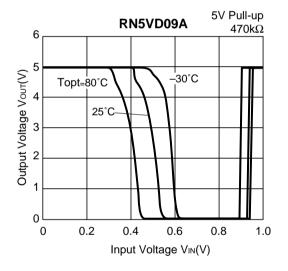


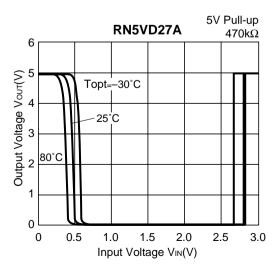


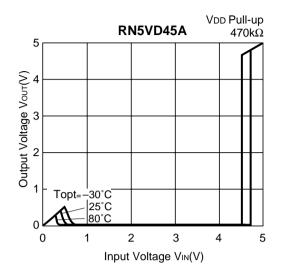
3) Output Voltage vs. Input Voltage

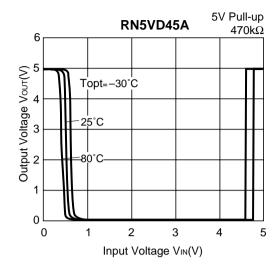




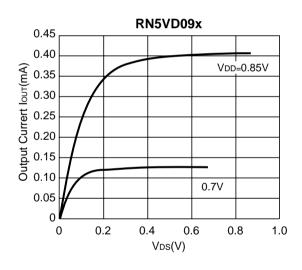


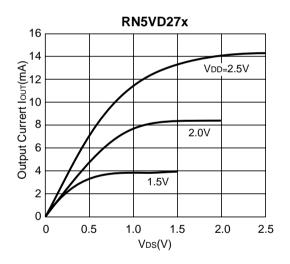


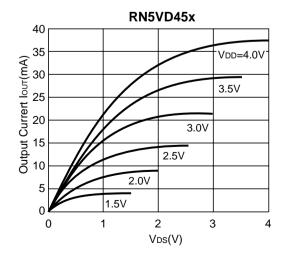




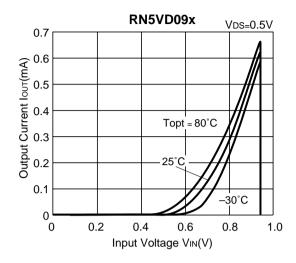
4) Nch Driver Output Current vs. VDS

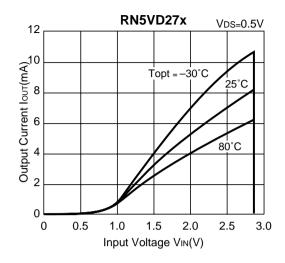


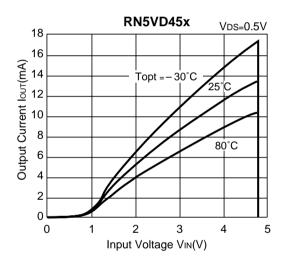




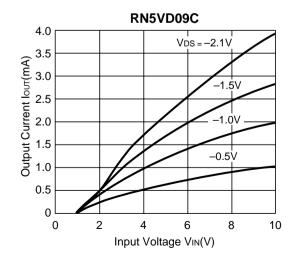
5) Nch Driver Output Current vs. Input Voltage

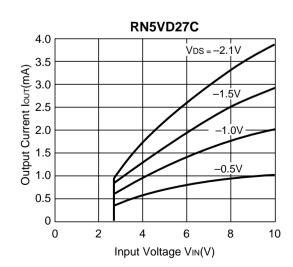


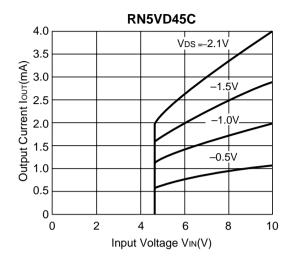




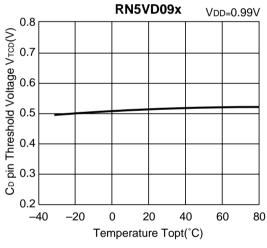
6) Pch Driver Output Current vs. Input Voltage

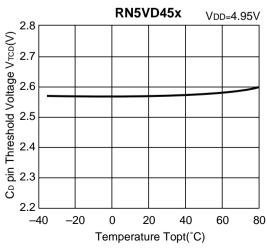


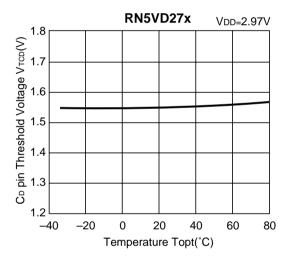




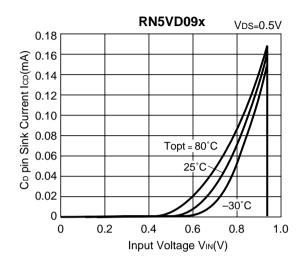
7) CD pin Threshold Voltage vs. Temperature

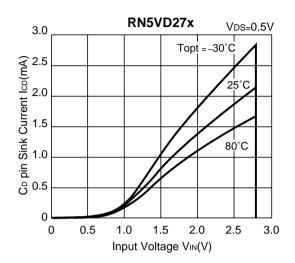


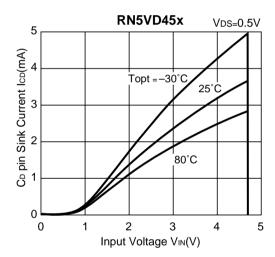




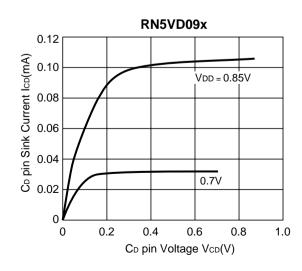
8) CD pin Sink Current vs. Input Voltage

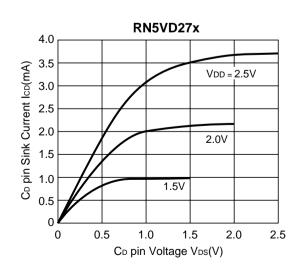


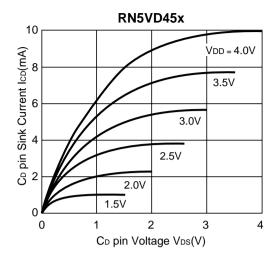




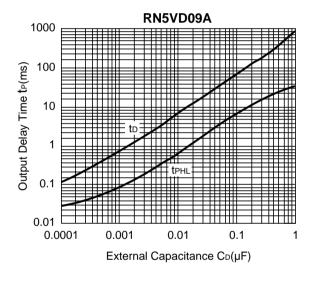
9) CD pin Sink Current vs. CD pin Voltage

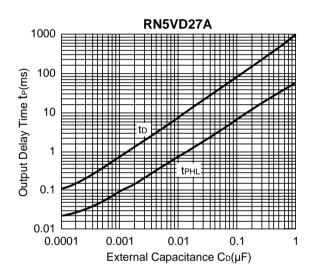


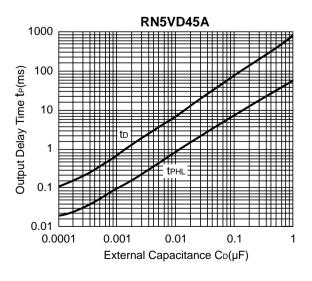




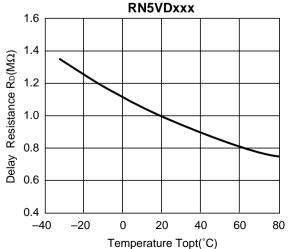
10) Output delay Time vs. External Capacitance





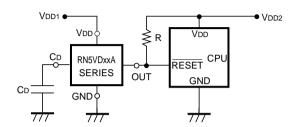


11) Delay Resistance vs. Temperature RN5VDxxx

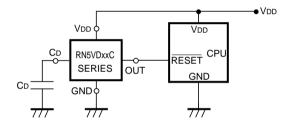


TYPICAL APPLICATIONS

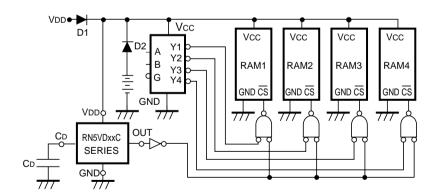
- RN5VDxxA CPU Reset Circuit (Nch Open Drain Output)
- (1) Input Voltage to RN5VDxxA is the same as the input voltage to CPU.
- (2) Input Voltage to RN5VDxxA is different from the input voltage to CPU.



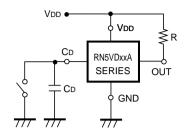
• RN5VDxxC CPU Reset Circuit (CMOS Output)

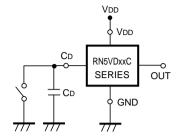


Memory Back-up Circuit



Manual Reset Circuit





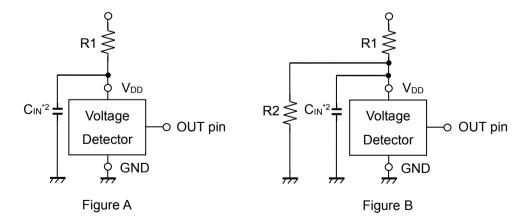
TECHNICAL NOTES

When connecting resistors to the device's input pin

When connecting a resistor (R1) to an input of this device, the input voltage decreases by [Device's Consumption Current] x [Resistance Value] only. And, the cross conduction current*1, which occurs when changing from the detecting state to the release state, is decreased the input voltage by [Cross Conduction Current] x [Resistance Value] only. And then, this device will enter the re-detecting state if the input voltage reduction is larger than the difference between the detector voltage and the released voltage.

When the input resistance value is large and the VDD is gone up at mildly in the vicinity of the released voltage, repeating the above operation may result in the occurrence of output.

As shown in Figure A/B, set R1 to become 100 k Ω or less as a guide, and connect C_{IN} of 0.1 μ F and more to between the input pin and GND. Besides, make evaluations including temperature properties under the actual usage condition, with using the evaluation board like this way. As a result, make sure that the cross conduction current has no problem.



^{*1} In the CMOS output type, a charging current for OUT pin is included.

^{*2} Note the bias dependence of capacitors.



- The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to our sales representatives for the latest information thereon.
- 2. The materials in this document may not be copied or otherwise reproduced in whole or in part without prior written consent of our company.
- 3. Please be sure to take any necessary formalities under relevant laws or regulations before exporting or otherwise taking out of your country the products or the technical information described herein.
- 4. The technical information described in this document shows typical characteristics of and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under our company's or any third party's intellectual property rights or any other rights.
- 5. The products listed in this document are intended and designed for use as general electronic components in standard applications (office equipment, telecommunication equipment, measuring instruments, consumer electronic products, amusement equipment etc.). Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death (aircraft, spacevehicle, nuclear reactor control system, traffic control system, automotive and transportation equipment, combustion equipment, safety devices, life support system etc.) should first contact us.
- 6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
- 7. Anti-radiation design is not implemented in the products described in this document.
- 8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.
- 11. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information

